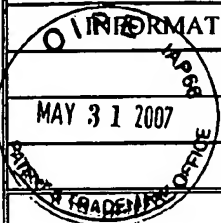


U.S. Department of Commerce, Patent and Trademark Office				Atty. Docket No.		Serial No.		
				AB-1615 US		10/747,672		
				INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)				
				Applicant(s)		LEE, Sang-Duk		
				Filing Date		Group		
				12/30/2003		1563		
U.S. Patent Documents								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA							
	AB							
	AC							
	AD							
	AE							
	AF							
	AG							
	AH							
	AI							
	AJ							
	AK							
Foreign Patent Documents								
							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
/LN/	AL	3-243922	10/30/1991	Japan				X
↓	AM	10-135683	05/22/1998	Japan				X
	AN	11-281966	10/15/1999	Japan				X
	AO	2000-231104	08/22/2000	Japan				X
	AP	2002-333606	11/22/2002	Japan				X
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)								
	AQ	Patent Abstracts of Japan, Publication No. 03-243922, 10/30/1991, 2 pp.						
	AR	Patent Abstracts of Japan, Publication No. 10-135683, 05/22/1998, 2 pp.						
↓	AS	Patent Abstracts of Japan, Publication No. 11-281966, 10/15/1999, 2 pp.						
Examiner/Lauren Nguyen/ (10/04/2007) Date Considered								
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.								

U.S. Department of Commerce, Patent and Trademark Office					Atty. Docket No.		Serial No.	
					AB-1615 US		10/747,672	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT					Applicant(s)			
(Use several sheets if necessary)					LEE, Sang-Duk			
					Filing Date		Group	
					12/30/2003		1563	
U.S. Patent Documents								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA							
	AB							
	AC							
	AD							
	AE							
	AF							
	AG							
	AH							
	AI							
	AJ							
	AK							
Foreign Patent Documents								
							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
/LN/	AL	2002-333607	11/22/2002	Japan				X
/LN/	AM	2003-177379	06/27/2003	Japan				X
	AN							
	AO							
	AP							
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)								
/LN/	AQ	Patent Abstracts of Japan, Publication No. 2000-231104, 08/22/2000, 2 pp.						
/LN/	AR	Patent Abstracts of Japan, Publication No. 2002-333606, 11/22/2002, 2 pp.						
/LN/	AS	Patent Abstracts of Japan, Publication No. 2002-333607, 11/22/2002, 2 pp.						
Examiner/Lauren Nguyen/ (10/04/2007) Date Considered								
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.								

U.S. Department of Commerce, Patent and Trademark Office				Atty. Docket No.		Serial No.	
				AB-1615 US		10/747,672	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Applicant(s)			
(Use several sheets if necessary)				LEE, Sang-Duk			
				Filing Date		Group	
				12/30/2003		1563	
U.S. Patent Documents							
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
Foreign Patent Documents							
							Translation
		Document	Date	Country	Class	Subclass	Yes No
	AL						
	AM						
	AN						
	AO						
	AP						
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)							
/LN/	AQ	Patent Abstracts of Japan, Publication No. 2003-1777379, 06/27/2003, 1 p.					
/LN/	AR	Office Action mailed 02/27/2007 for corresponding Japanese Patent Application (5 pp.) NO ENGLISH TRANSLATION					
	AS						
Examiner/Lauren Nguyen/ (10/04/2007) Date Considered							
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.							

